



# Product Change Notification

**Change Notification #:** 116712 - 00  
**Change Title:** Intel® Server System R1208WTTGSR,  
PCN 116712 - 00, Label,  
Outer box label stacking logo update  
**Date of Publication:** January 14, 2019

## Key Characteristics of the Change:

Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	January 30, 2019
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

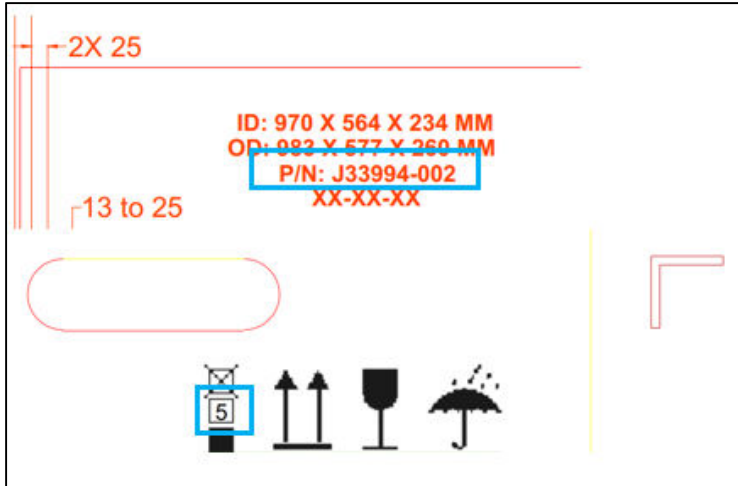
## Description of Change to the Customer:

Intel is updating the outer box label logo of the Intel Server Systems listed on the products affected table.

The previous logo means that the maximum layers supported in a pallet are 7 in total, however only 6 layers as maximum can be supported. The P/N (Product Number) of the label is being updated for listed products as follow.

- I. Intel Server 1U Systems and 1U Chassis updates the P/N from J34109-001 to J34109-002.
- II. Intel Server 2U Systems and 2U Chassis updates the P/N from J34107-001 to J34107-002.

The Image belows shows an example of the label logo P/N update.



Outer box label  
Logo example

**Customer Impact of Change and Recommended Action:**

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
R1208WTTGSR	977047	J11481-016	J11481-017

**PCN Revision History:**

**Date of Revision:**  
January 14, 2019

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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## 116712 - 00

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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